



ABSOLUTE MAXIMUM RATINGS ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)				
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
INPUT				
Reverse voltage		V_R	6	V
DC forward current		I_F	50	mA
Surge forward current	$t_p \leq 10\text{ }\mu\text{s}$	I_{FSM}	1.5	A
Total power dissipation		P_{diss}	80	mW
OUTPUT				
Collector emitter voltage		V_{CEO}	70	V
Emitter collector voltage		V_{ECO}	7	V
Collector current		I_C	50	mA
	$t_p = 1.0\text{ ms}$	I_C	100	mA
Total power dissipation per channel		P_{diss}	150	mW
COUPLER				
Storage temperature range		T_{stg}	-55 to +125	$^{\circ}\text{C}$
Ambient temperature range		T_{amb}	-55 to +100	$^{\circ}\text{C}$
Junction temperature		T_j	125	$^{\circ}\text{C}$
Soldering temperature ⁽¹⁾	Max. 10 s dip soldering distance to seating plane $\geq 1.5\text{ mm}$		260	$^{\circ}\text{C}$
Total power dissipation		P_{tot}	250	mW

Notes

- Stresses in excess of the absolute maximum ratings can cause permanent damage to the device. Functional operation of the device is not implied at these or any other conditions in excess of those given in the operational sections of this document. Exposure to absolute maximum ratings for extended periods of the time can adversely affect reliability
- ⁽¹⁾ Refer to reflow profile for soldering conditions for surface mounted devices

ELECTRICAL CHARACTERISTICS ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
INPUT						
Forward voltage	$I_F = 5\text{ mA}$	V_F	-	1.15	1.4	V
Reverse current	$V_R = 6\text{ V}$	I_R	-	0.01	10	μA
Capacitance	C_O	C_O	-	8	-	pF
OUTPUT						
Collector emitter leakage current	$V_{CE} = 20\text{ V}$	I_{CEO}	-		100	nA
Collector emitter capacitance	$V_{CE} = 5\text{ V}, f = 1\text{ MHz}$	C_{CE}	-	6.0	-	pF
COUPLER						
Collector emitter saturation voltage	$I_F = 20\text{ mA}, I_C = 1\text{ mA}$	V_{CEsat}	-	0.1	0.4	V
Coupling capacitance	$f = 1\text{ MHz}$	C_C	-	1	-	pF

Note

- Minimum and maximum values are testing requirements. Typical values are characteristics of the device and are the result of engineering evaluation. Typical values are for information only and are not part of the testing requirements

CURRENT TRANSFER RATIO ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Current transfer ratio	$I_F = 5\text{ mA}, V_{CC} = 5\text{ V}$	CTR	50	-	300	%

SWITCHING CHARACTERISTICS ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
NON-SATURATED						
Rise time	$I_C = 2\text{ mA}$, $V_{CC} = 5\text{ V}$, $R_L = 100\ \Omega$	t_r	-	5.5	-	μs
Fall time	$I_C = 2\text{ mA}$, $V_{CC} = 5\text{ V}$, $R_L = 100\ \Omega$	t_f	-	7	-	μs
Turn-on time	$I_C = 2\text{ mA}$, $V_{CC} = 5\text{ V}$, $R_L = 100\ \Omega$	t_{on}	-	9.5	-	μs
Turn-off time	$I_C = 2\text{ mA}$, $V_{CC} = 5\text{ V}$, $R_L = 100\ \Omega$	t_{off}	-	8.5	-	μs
SATURATED						
Turn-on time	$I_F = 10\text{ mA}$, $V_{CC} = 5\text{ V}$, $R_L = 1\text{ k}\Omega$	t_{on}	-	3	-	μs
Turn-off time	$I_F = 10\text{ mA}$, $V_{CC} = 5\text{ V}$, $R_L = 1\text{ k}\Omega$	t_{off}	-	20	-	μs

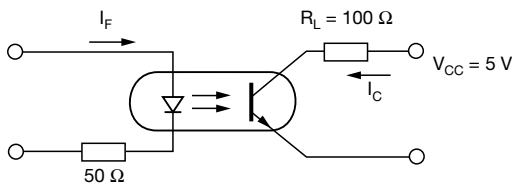


Fig. 1 - Switching Operation (without saturation)

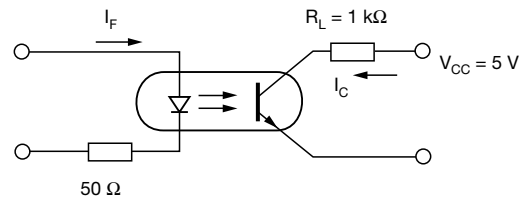


Fig. 2 - Switching Operation (with saturation)

SAFETY AND INSULATION RATINGS				
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
Climatic classification	According to IEC 68 part 1		55 / 100 / 21	
Comparative tracking index		CTI	175	
Maximum rated withstanding isolation voltage	According to UL1577, $t = 1\text{ min}$	V_{ISO}	3750	V_{RMS}
Maximum transient isolation voltage	According to DIN EN 60747-5-5	V_{IOTM}	6000	V_{peak}
Maximum repetitive peak isolation voltage	According to DIN EN 60747-5-5	V_{IORM}	707	V_{peak}
Isolation resistance	$V_{IO} = 500\text{ V}$, $T_{amb} = 25\text{ }^{\circ}\text{C}$	R_{IO}	$\geq 10^{12}$	Ω
	$V_{IO} = 500\text{ V}$, $T_{amb} = 100\text{ }^{\circ}\text{C}$	R_{IO}	$\geq 10^{11}$	Ω
Output safety power		P_{SO}	350	mW
Input safety current		I_{SI}	200	mA
Safety temperature		T_S	175	$^{\circ}\text{C}$
Creepage distance			≥ 5	mm
Clearance distance			≥ 5	mm
Insulation thickness		DTI	≥ 0.4	mm

Note

- As per IEC 60747-5-5, § 7.4.3.8.2, this optocoupler is suitable for “safe electrical insulation” only within the safety ratings. Compliance with the safety ratings shall be ensured by means of protective circuits

TYPICAL CHARACTERISTICS ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)

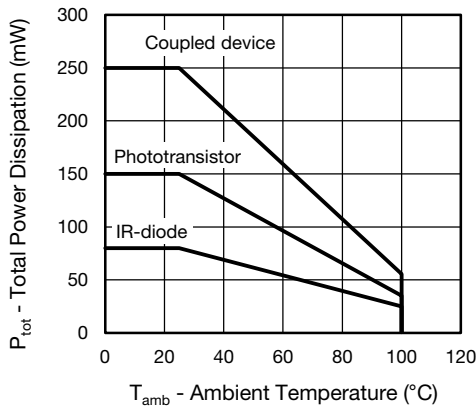


Fig. 3 - Total Power Dissipation vs. Ambient Temperature

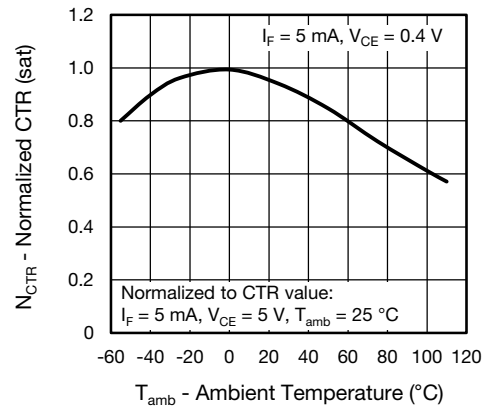


Fig. 6 - Normalized Current Transfer Ratio (saturated) vs. Ambient Temperature

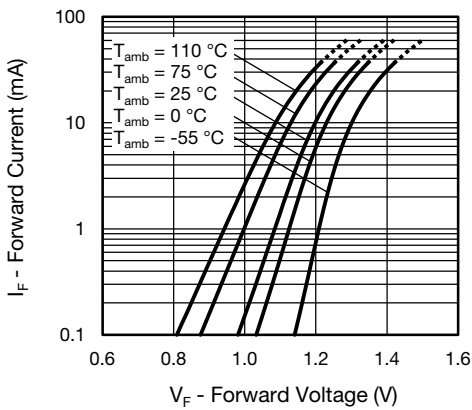


Fig. 4 - Forward Voltage vs. Forward Current

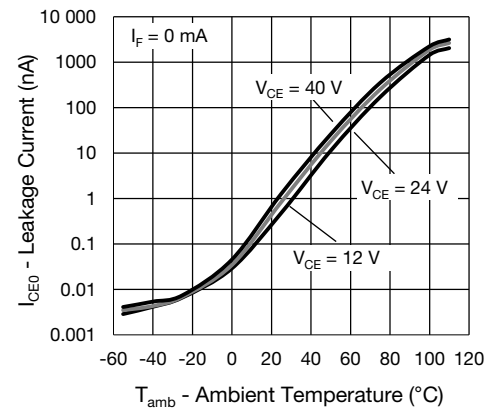


Fig. 7 - Collector Dark Current vs. Ambient Temperature

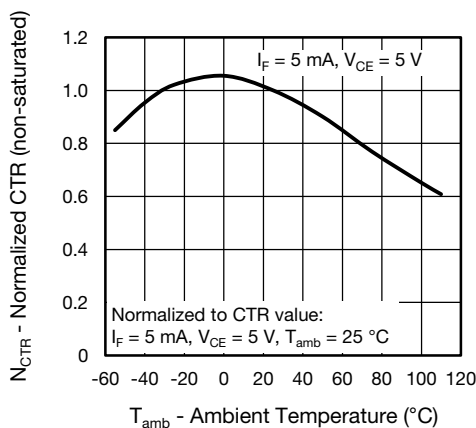


Fig. 5 - Normalized Current Transfer Ratio (non-saturated) vs. Ambient Temperature

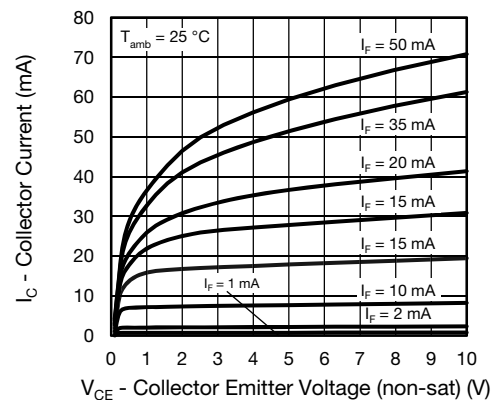


Fig. 8 - Collector Current vs. Collector Emitter Voltage (non-saturated)

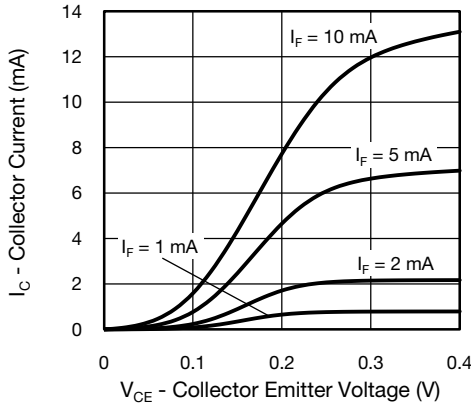


Fig. 9 - Collector Current vs. Collector Emitter Voltage (saturated)

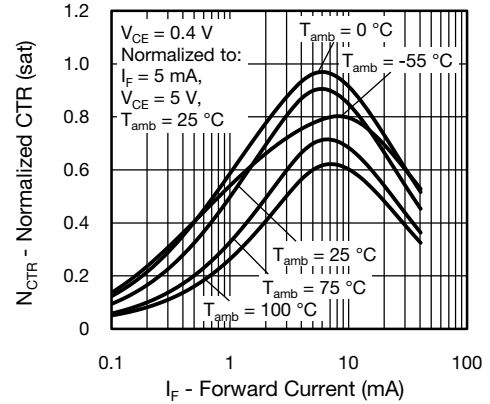


Fig. 12 - Normalized CTR (saturated) vs. Forward Current

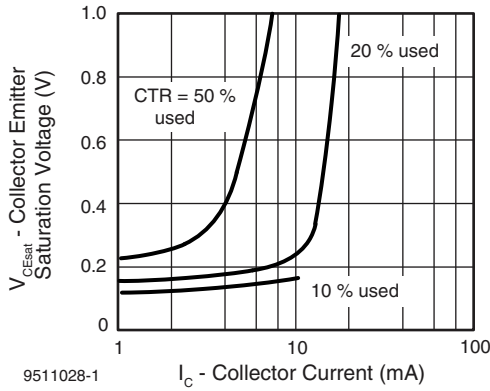


Fig. 10 - Collector Emitter Saturated Voltage vs. Collector Current

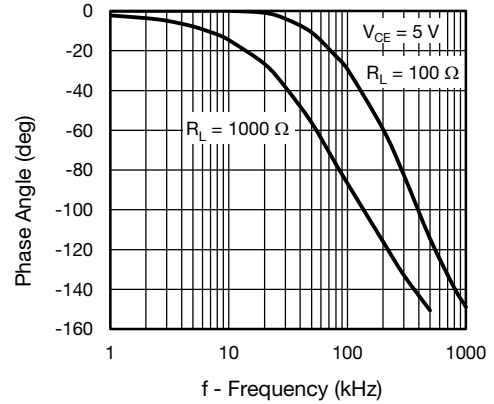


Fig. 13 - F_{CTR} vs. Phase Angle

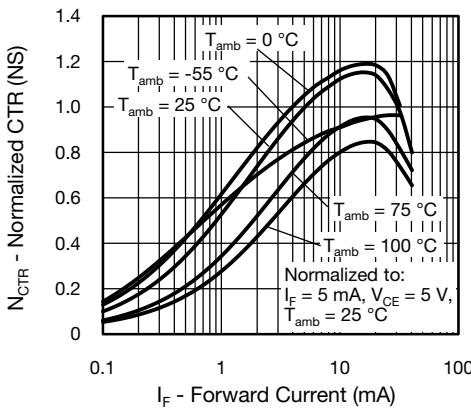


Fig. 11 - Normalized CTR (non-saturated) vs. Forward Current

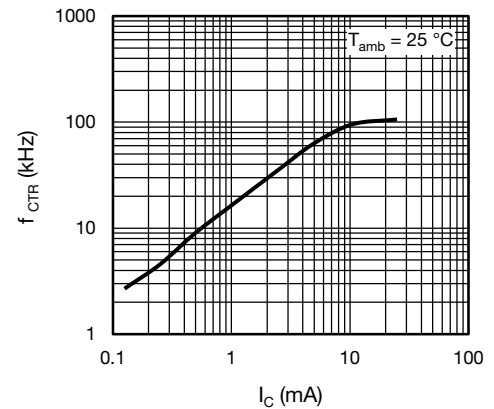


Fig. 14 - f_{CTR} vs. Collector Current

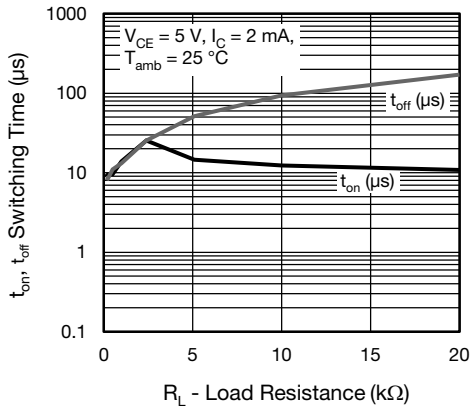
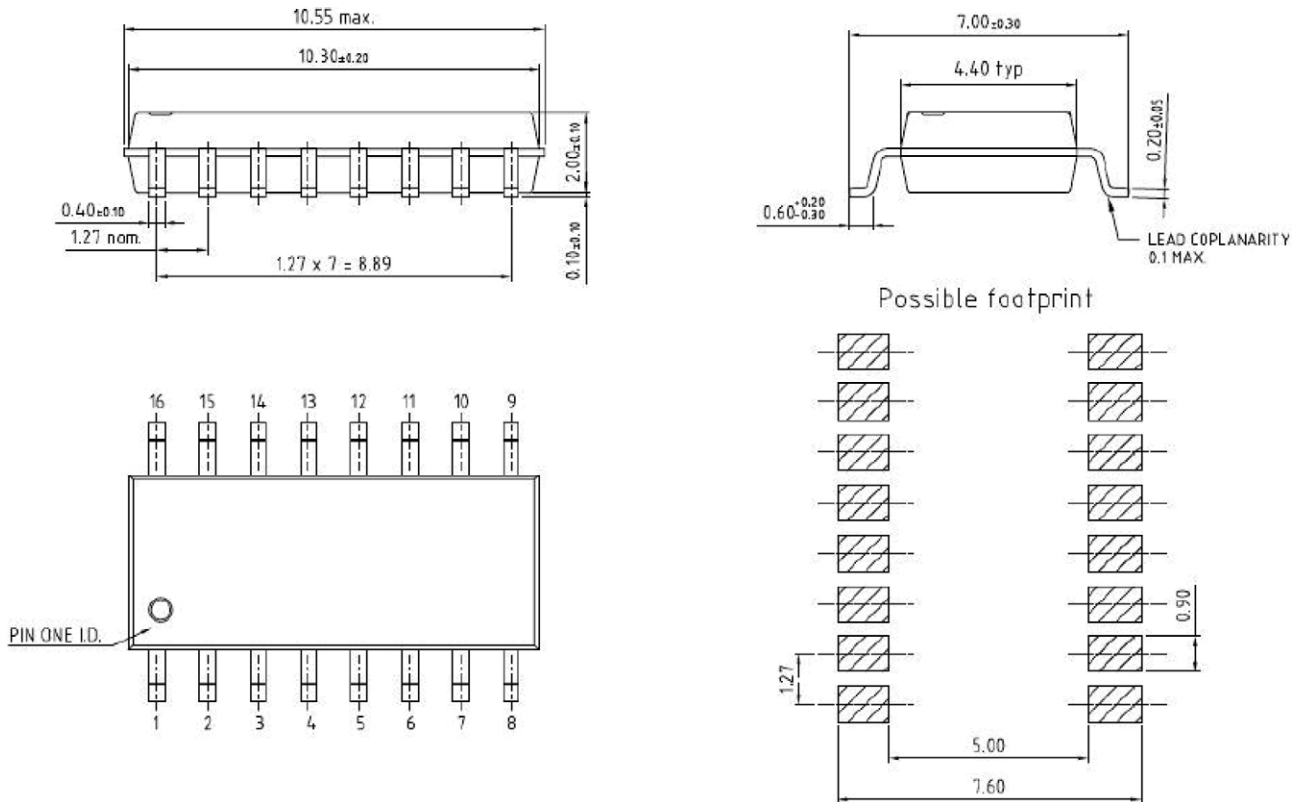
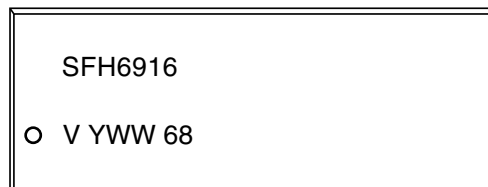


Fig. 15 - Switching Time vs. Load Resistance

PACKAGE DIMENSIONS in millimeters



PACKAGE MARKING



TAPE AND REEL PACKAGING in millimeters

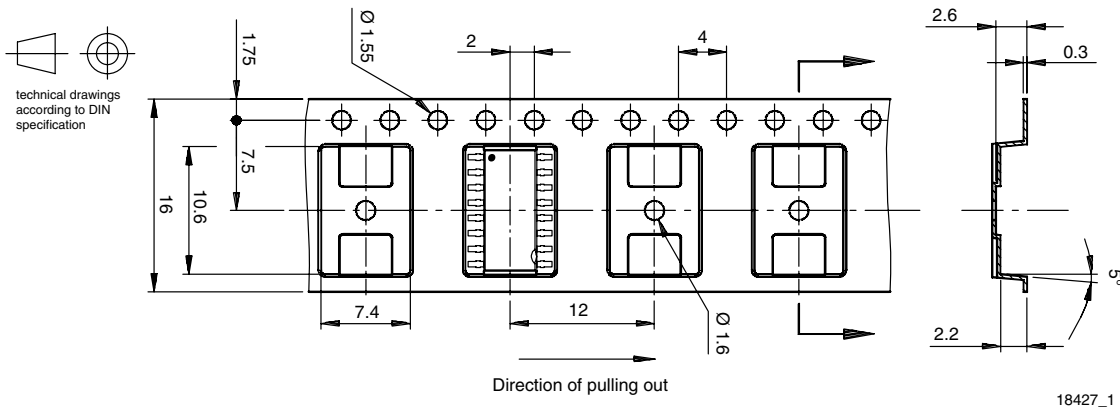
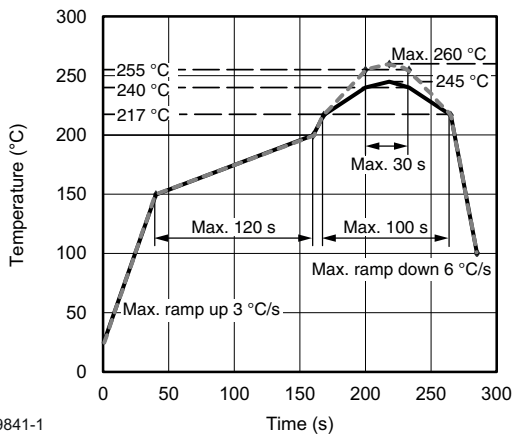


Fig. 16 - 2000 pcs/reel

SOLDER PROFILE



19841-1

Fig. 17 - Lead (Pb)-free Reflow Solder Profile according to J-STD-020

HANDLING AND STORAGE CONDITIONS

ESD level: HBM class 2

Floor life: unlimited

Conditions: $T_{amb} < 30\text{ °C}$, RH < 85 %

Moisture sensitivity level 1, according to J-STD-020



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